## Bill of Materials

**TI DESIGNS**

**TIDA-00347 (Low Frequency)**

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<tr>
<th>Item</th>
<th>Qty</th>
<th>Reference</th>
<th>Value</th>
<th>Part Description</th>
<th>Manufacturer</th>
<th>Manufacturer Part Number</th>
<th>Alternate Part</th>
<th>PCB Footprint</th>
<th>Note</th>
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